

Specification for Approval

Customer:_____

Model Name:

Sı	upplier Approv	Customer approval	
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		



Revision Record

REV NO.	REV DATE	CONTENTS	Note
А	2024-01-08	NEW ISSUE	



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1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

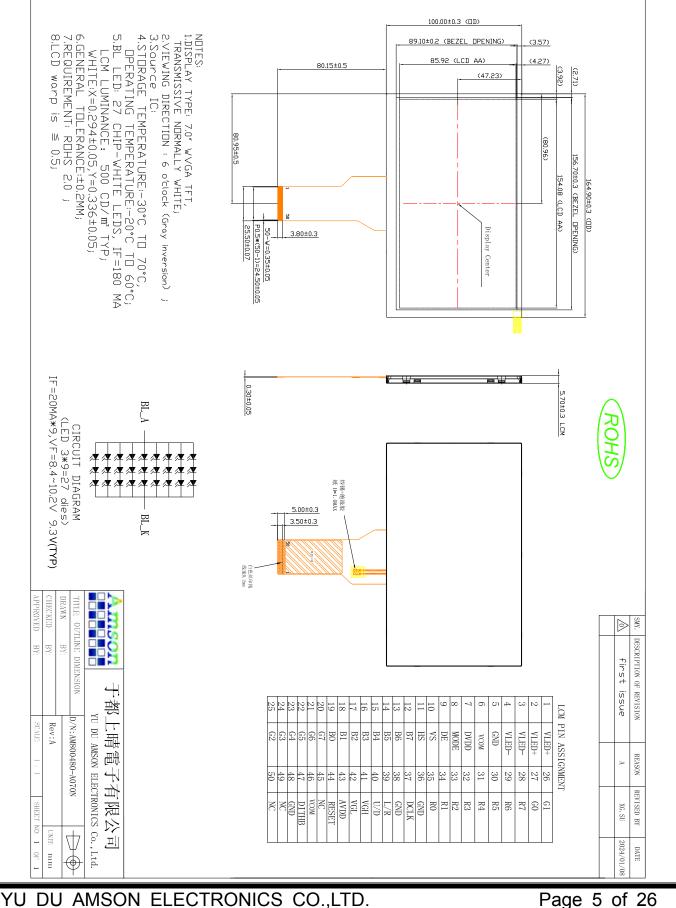
If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

2. General Information

Features	Details	Unit
Display Size(Diagonal)	7.0"	
LCD type	TN TFT	
DisplayMode	Transmissive /Normal white	
Resolution	800RGBx 480	Pixels
ViewDirection	12O'clock	BestImage
Gray ScaleInversionDirection	6O'clock	
Module Outline	164.9(H) x100(V) x 5.7(T) (Note1)	mm
ActiveArea	154.08(H) x85.92(V)	mm
PixelSize	192.6(H) x179(V)	um
PixelArrangement	R.G.BStripe	
Polarizer Surface Treatment	Anti-glare	
Display Colors	16.7M	
Interface	24BitRGB	
With or Without TouchPanel	Without	
Operating Temperature	-20~60	°C
Storage Temperature	-30~70	٥C
Weight	150	g



3. External Dimensions



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4. Interface Description

PIN	PIN NAME	DESCRIPTION					
1	LEDA	LED backlight (Anode).					
2	LEDA	<u> </u>					
3	LEDK	LED backlight (Cathode).					
4	LEDK						
5	GND	Power ground					
6	VCOM	NC					
7	DVDD	Digital Power.					
8	MODE	DE/SYNC mode select. Normally pull high. H: DE mode. L: HSD/VSD mode.					
9	DE	Data Enable signal.					
10	VS	Vertical sync input. Negative polarity.					
11	HS	Horizontal sync input. Negative polarity.					
12~19	B7~B0	Blue Data Input					
20~27	G7~G0	Green Data Input					
28~35	R7~R0	Red Data Input					
36	GND	Power ground.					
37	DCLK	Clock input.					
38	GND	Power ground.					
39	L/R	Left or Right Display Control.					
40	U/D	Up / Down Display Control.					
41	VGH	Positive Power for TFT.					
42	VGL	Negative Power for TFT.					
43	AVDD	Analog Power.					
44	RESET	Global reset pin. Active low to enter reset state. Suggest to connecting with an RC reset circuit for stability. Normally pull high.(R=10K Ω , C=1 μ F)					
45	NC.	Not connect.					
46	VCOM	NC					
47	DITHB	Dithering function enable control. (Normally pull high) DITHB="L", to enable internal dithering function. DITHB="H", to disable internal dithering function.					
48	GND	Power ground.					



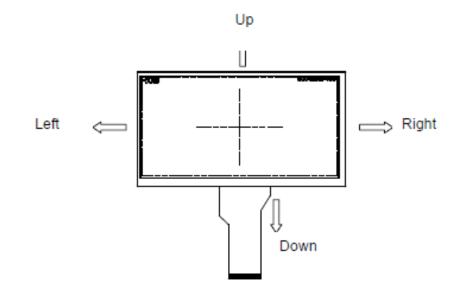
49	NC.	Not connect.
50	NC.	Not connect.

[Note1] L/R : left or right setting

U/D : up or down setting

I								
L/R	U/D	Data shifting						
DVDD	GND	Left \rightarrow Right, Up \rightarrow Down(default)						
GND	GND	Right \rightarrow Left, Up \rightarrow Down						
DVDD	DVDD	Left \rightarrow Right, Down \rightarrow Up						
GND	DVDD	Right \rightarrow Left, Down \rightarrow Up						

Definition of scanning direction:





				100 01, 10 E0 0
Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	5.0	V
Storage temperature	TSTG	-30	70	٥C
Operating temperature	ТОР	-20	60	°C

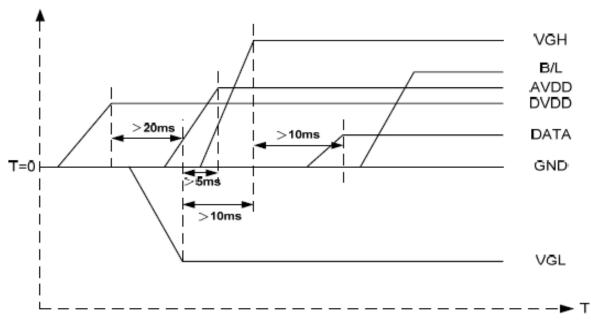
6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Digital Power Supply Voltage	DVDD	3.0	3.3	3.6	V
Analog Power Supply Voltage	AVDD	10.2	10.4	10.6	V
TFT Device on Voltage	VGH	14.5	15.0	15.5	V
TFT Device off Voltage	VGL	-10.5	-10.0	-9.5	V
Common Electrode Driving Voltage	VCOM	3.54	4.04	4.54	V
Low LevelInput Voltage	VIL	0	-	0.3*DVDD	V
High LevelInput Voltage	VIH	0.7*DVDD	-	DVDD	V



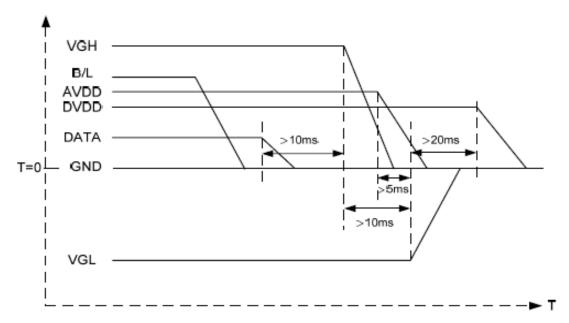
VSS=0V. Ta=25°C

- 7. Timing Characteristics
- 7.1 Power sequence
 - a. Power on:



 $DV_{DD} \rightarrow VGL \rightarrow VGH \rightarrow Data \rightarrow B/L$

b. Power off:



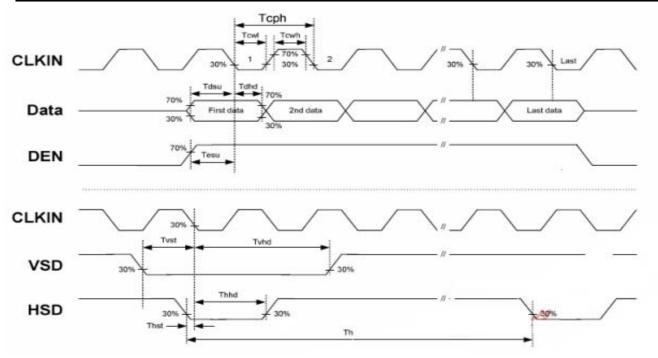
$B/L \rightarrow Data \rightarrow VGH \rightarrow VGL \rightarrow DV_{DD}$

Note: Data include R0~R7, B0~B7, GO~G7, U/D, L/R, DCLK, HS,VS,DE.



7.2 Timing characteristics 7.2.1 AC Electrical Characteristics

ltem	Symbol		Values		Unit	Remark
item	Symbol	Min.	Тур.	Max.	onit	Kellidik
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	ŀ	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hole time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hole time	Tehd	8	-	-	ns	
DV _{DD} Power On Slew rate	TPOR	-	-	20	ms	From 0 to 90% DV _{DD}
RESET pulse width	T _{Rst}	1	-	-	ms	
DCLK cycle time	Tcoh	20	-	-	ns	
DCLK pulse duty	Towh	40	50	60	%	



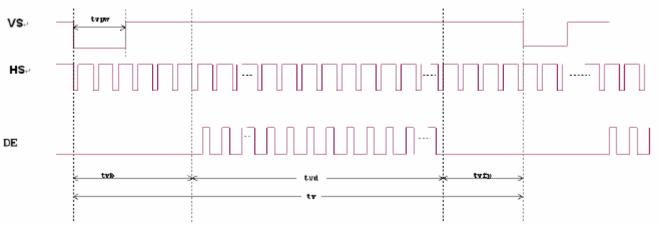
YU DU AMSON ELECTRONICS CO., LTD.



7.2.2 Data Input Format



Horizontal input timing diagram



Vertical input timing diagram



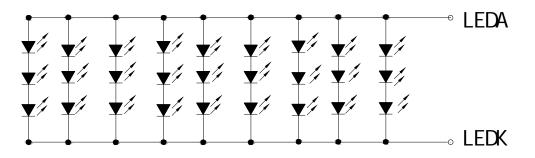
7.2.3 Timing

ltem	Symbol				Unit	Remark
Rom	Symbol	Min.	Тур.	Max.	Onic	Kellark
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	th	862	1056	1200	DCLK	
HS pulse width	thpw	1	-	40	DCLK	
HS Blanking	thb	46	46	46	DCLK	
HS Front Porch	thfp	16	210	354	DCLK	

ltem	Symbol		Values	Unit	Remark	
item	Symbol	Min.	Тур.	Max.	onin	Kelliark
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	510	525	650	TH	
VS pulse width	tvpw	1	-	20	TH	
VS Blanking	tvb	23	23	23	TH	
VS Front Porch	tvfp	7	22	147	TH	



8. Backlight Characteristic



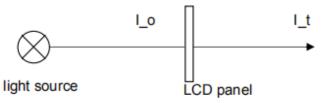
ltem	Symbol	MIN	ТҮР	MAX	UNIT	Test Condition
Supply Voltage	Vf	8.4	9.3	10.2	V	lf=180mA
Supply Current	lf	-	180		mA	-
Luminous Intensity for LCM	-	-	500	-	cd/m ²	lf=180mA
Uniformity for LCM	-	70	75	-	%	lf=180mA
Life Time	-	-	30000	-	Hr	lf=180mA
Backlight Color			١	Nhite		

9. Optical Characteristics

ltem	Conditions		Min.	Тур.	Max.	Unit	Note
Viewing Angle	Horizontal	θL	60	70	-	degree	(1),(2),(6)
	TIONZONIA	θR	60	70	-		
(CR>10)	Vertical	θт	40	50	-		
	Ventical	θв	60	70	-		
Contrast Ratio	Center		-	500	-	-	(1),(3),(6)
	TR		-	10	20		
Response Time	TF		-	15	30	ms	(1),(4),(6)
	Red x Red y Green x Green y			0.581		-	- Chromaticity measuring
			-	0.311		-	
				0.311		-	
CF Color Chromaticity				0.555		-	
(CIE1931)	Blue x		Тур. -0.05	0.136	Тур. +0.05	-	machine: CFT-01. Reference Only
	Blue y		-0.05	0.119	10.00	-	Telefence Only
	White x			0.310		-	
	White y			0.330		-	

[1]Transmittance (T %)

The transmittance of the panel including polarizer is measured with electrical driving.



The Transmittance is defined as:

$$Tr = \frac{I_t}{I_o} \times 100\%$$

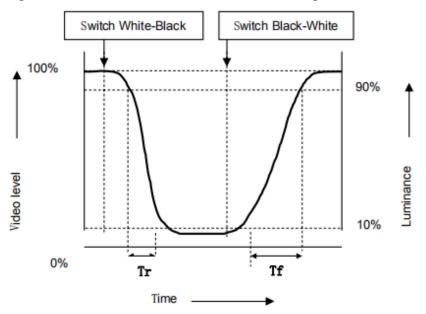
here,

I_o: the brightness of the light source. I_t : the brightness after panel transmission.



[2] Response Time(Tr、Tf)

The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.

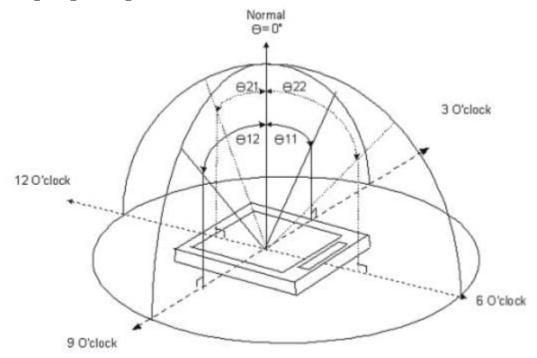


[3] Contrast ratio (Cr)

The contrast ratio (Cr), measured on a module, is the ratio between the luminance (L_w) in a full white area (R=G=B=1) and the luminance (L_d) in a dark area (R=G=B=0):

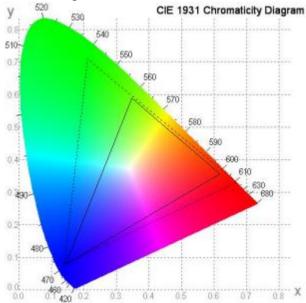
$$\operatorname{Cr} = \frac{L_w}{L_d}$$

[4] Viewing angle diagram



[5] Definition of color gamut

Measuring machine:CFT-01. NTSC' S Primaries: R(x,y,Y)、 G(x,y,Y)、 B(x,y,Y)





10. Reliability Test Conditions and Methods

No	ltem	Condition	Quantity	Criteria
1	High Temperature Operating	60℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	HighHumidity	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	70 ℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-30℃, 60min~70℃, 60min, 20cycles.	2	GB/T2423.2 2-2012
7	Packing vibration	Frequencyrange:10Hz~50Hz Accelerationofgravity:5G X, Y, Z 30minforeachdirection.	2	GB/T5170.1 4-2009
		Air:±8KV150pF/330Ω 5 times		GB/T17626.
8	Electrical StaticDischarge	Contact:±4KV150pF/330Ω 5 times	2	2-2006
9	Drop Test (Packaged)	Height:80 cm,1 corner,3 edges, 6 surfaces.	2	GB/T2423.8 -1995



11. Inspection Standard

11.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2 Standard for Quality Test

- 11.2.1 Sampling Plan:
 - GB2828.1-2012.

Single sampling, normal inspection.

11.2.2 Sampling Criteria:

Visual inspection: AQL1.5%

Electrical functional: AQL 0.65%.

11.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3 Nonconforming Analysis & Disposition

11.3.1Nonconforming analysis:

11.3.1.1Customer should provide overall information of non-conforming sample for their complaints.

11.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

11.3.1.3 If can not finish the analysis on time, customer will be notified with the progress status.

11.3.2 Disposition of nonconforming:

11.3.2.1 Non-conforming product over PPM level will be replaced.

11.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4 Agreement Items

Shall negotiate with customer if the following situation occurs:

- 11.4.1 There is any discrepancy in standard of quality assurance.
- 11.4.2 Additional requirement to be added in product specification.
- 11.4.3 Any other special problem.

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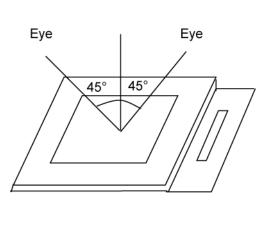
11.5 Standard of the Product Visual Inspection

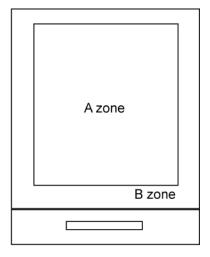
11.5.1 Appearance inspection:

11.5.1.1 The inspection must be under illumination about 1000-1500lx, and the distance of view must be at 30cm±2cm.

11.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

11.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,





11.5.2 Basic principle:

11.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

11.5.2.2 New item must be added on time when it is necessary.

No.	ltem	Criteria (Unit:mm)			
	Black / White spot Foreign material	Area Acc. Qty			
	(Round type)	φ≤0.20 Ignore			
01	Pinholes Stain	b 0.20<φ≤0.50 N≤3 0.50<φ			
	Particles inside cell. (Minor defect)	ϕ = (a + b)/2 Distance between 2 defects should more than 5mm apart.			



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			L		
		Bright dot	Display Area	Total	
		Bright dot	N≤2	N≤2	Note1
02		Dark dot	N≤4	N≤4	NOLET
	Electrical Defect	Total dot	N≤4	N≤4	
02	(Minor defect)	Mura	Not visible throug filters.	n 5% ND	Note 2
		Remark: 1. Bright dot causec	by scratch and foreign	object accords	to item 1.
	Black and White			L	
03	line Scratch	ΛL			
03		Length	Width	Acc. Qty	
03	Scratch Foreign material	Length	Width ₩ ≦ 0.1	Acc. Qty Ignore	
03	Scratch Foreign material (Line type)				
03	Scratch Foreign material (Line type)	/	W ≦ 0.1	Ignore	
03	Scratch Foreign material (Line type)	/ L ≦ 2.5	$W \leq 0.1$ $0.1 < W \leq 0.2$	Ignore 3	
03	Scratch Foreign material (Line type) (Minor defect)	/ $L \leq 2.5$ L>2.5 Distance between 2	$\frac{W}{0.1} \le 0.1$ 0.1 < W \le 0.2 0.2 < W	Ignore 3 0 3 han 3mm apar	t. Scratches not
03	Scratch Foreign material (Line type) (Minor defect)	/ $L \leq 2.5$ L>2.5 Distance between 2	$W \leq 0.1$ $0.1 < W \leq 0.2$ $0.2 < W$ Total $defects should more the statement of the statem$	Ignore 3 0 3 han 3mm apar	t. Scratches not
	Scratch Foreign material (Line type) (Minor defect) Glass Crack (Minor defect)	i $L \leq 2.5$ L > 2.5 Distance between 2 viewable through the	$W \leq 0.1$ $0.1 < W \leq 0.2$ $0.2 < W$ Total $defects should more the statement of the statem$	Ignore 3 0 3 han 3mm apar e acceptable.	t. Scratches not



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	Glass Chipping Pad Area:			
	(Minor defect)	Length and Width	Acc. Qty	
		c > 3.0, b< 1.0	1	
05		c< 3.0, b< 1.0	3	
00		a <glass td="" thick<=""><td></td></glass>		
	baga co			
	Glass Chipping Rear of Pad Area: (Minor defect)			
		Length and Width	Acc. Qty	
	\mathbf{i}	c > 3.0, b< 1.0	1	
06		c< 3.0, b< 1.0	2	
		c< 3.0, b< 0.5	4	
	b 3 g a	a <glass td="" thick<=""><td>INESS</td></glass>	INESS	
	Glass Chipping Except Pad Area: (Minor defect)			
		Length and Width	Acc. Qty	
		c > 3.0, b< 1.0	1	
07		c< 3.0, b< 1.0	2	
		c< 3.0, b< 0.5	4	
		a < Glass Thickness		
	at			
	Glass Corner Chipping: (Minor defect)			
		Length and Width	Acc. Qty	
	\searrow	c < 3.0, b< 3.0	Ignore	
08		a <glass td="" thick<=""><td>iness</td></glass>	iness	
	b at the contract of the contr			



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- 1

	Glass Burr: (Minor defect)			Leng F <		Acc. Qty Ignore
09						
			Glass burr don't affect assemble module dimension.			
10	FPC Defect: (Minor defect) w → v a → v	- ←	(w: c 10.2	Dent, pinhole rcuitry width.) Open circuit i No oxidation,	s unaccepta	
			Di	ameter	Acc. Q	4 17
	Bubble on Polarizer			0.30	Ignore	
11				<φ≤0.50	N≤2	·
	(Minor defect)			60 < φ	N=0	
			Dia	ameter	Acc. Q	ty
40	Dent on Polarizer		φ≤	0.25	Ignore	9
12	(Minor defect)		0.25	<φ≤0.50	N≤4	
			0.5	50 < φ	None	
13	Bezel	13.1 No rust, distor 13.2 No visible fing			ner contami	nation.



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14	Touch Panel	D: Diameter W: width L: length 14.1 Spot: D<0.25 is acceptable 0.25≤D≤0.4 2dots are acceptable and the distance between defects should more than 10 mm. D>0.4 is unacceptable 14.2 Dent: D>0.40 is unacceptable 14.3 Scratch: W≤0.03, L≤10 is acceptable, 0.03 <w≤0.10, acceptable<br="" is="" l≤10="">Distance between 2 defects should more than 10 mm. W>0.10 is unacceptable.</w≤0.10,>
15	PCB	15.1 No distortion or contamination on PCB terminals.15.2 All components on PCB must same as documented on the BOM/component layout.15.3 Follow IPC-A-600F.
16	Soldering	Follow IPC-A-610C standard
17	Electrical Defect (Major defect)	 The below defects must be rejected. 17.1 Missing vertical / horizontal segment, 17.2 Abnormal Display. 17.3 No function or no display. 17.4 Current exceeds product specifications. 17.5 LCD viewing angle defect. 17.6 No Backlight. 17.7 Dark Backlight. 17.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable. **11.7 Classification of Defects**

11.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major. 10.7.2 Two minor defects are equal to one major in lot sampling inspection.

11.8 Identification/marking criteria

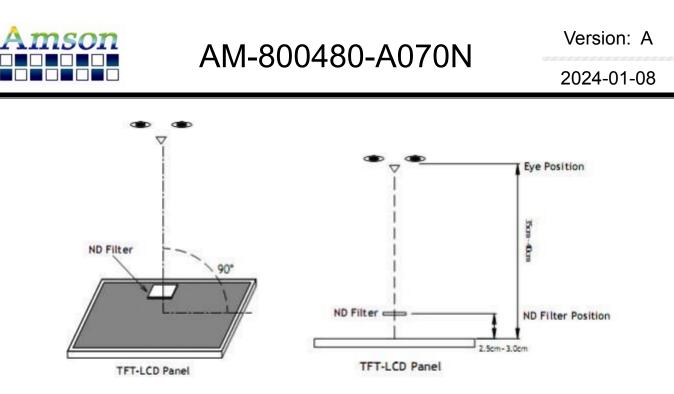
Any unit with illegible / wrong /double or no marking/ label shall be rejected.

11.9 Packing

11.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.

- 11.9.2 Modules inside package box should have compliant mark.
- 11.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm±50mm. Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm±50mm. Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.



12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

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• Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.

[It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method TBD.